74LVC169

Presettable synchronous 4-bit up/down binary counter

Rev. 6 — 29 November 2012

Product data sheet

1. General description

The 74LVC169 is a synchronous presettable 4-bit binary counter which features an internal look-ahead carry circuitry for cascading in high-speed counting applications. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs (pins Q0 to Q3) change simultaneously with each other when so instructed by the count-enable (pins CEP and CET) inputs and internal gating. This mode of operation eliminates the output counting spikes that are normally associated with asynchronous (ripple clock) counters. A buffered clock (pin CP) input triggers the four flip-flops on the LOW-to-HIGH transition of the clock.

The counter is fully programmable; that is, the outputs may be preset to any number between 0 and its maximum count. Presetting is synchronous with the clock and takes place regardless of the levels of the count enable inputs. A LOW level on the parallel enable (pin $\overline{\text{PE}}$) input disables the counter and causes the data at the Dn input to be loaded into the counter on the next LOW-to-HIGH transition of the clock. The direction of the counting is controlled by the up/down (pin U/ $\overline{\text{D}}$) input. When pin U/ $\overline{\text{D}}$ is HIGH, the counter counts up, when LOW, it counts down.

The look-ahead carry circuitry is provided for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable (pins $\overline{\text{CEP}}$ and $\overline{\text{CET}}$) inputs and a terminal count (pin $\overline{\text{TC}}$) output. Both count-enable (pins $\overline{\text{CEP}}$ and $\overline{\text{CET}}$) inputs must be LOW to count. Input pin $\overline{\text{CET}}$ is fed forward to enable the terminal count (pin $\overline{\text{TC}}$) output. Pin $\overline{\text{TC}}$ thus enabled will produce a LOW-level output pulse with a duration approximately equal to a HIGH level portion of pin Q0 output. The LOW level pin $\overline{\text{TC}}$ pulse is used to enable successive cascaded stages.

The 74LVC169 uses edge triggered J-K type flip-flops and has no constraints on changing the control of data input signals in either state of the clock. The only requirement is that the various inputs attain the desired state at least a set-up time before the next LOW-to-HIGH transition of the clock and remain valid for the recommended hold time thereafter.

The parallel load operation takes <u>precedence</u> over the other operations, as indicated in the mode select table. When pin PE is LOW, the data on the input pins D0 to D3 enters the flip-flops on the next LOW-to-HIGH transition of the clock.



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In order for counting to occur, both pins $\overline{\text{CEP}}$ and $\overline{\text{CET}}$ must be LOW and pin $\overline{\text{PE}}$ must be HIGH. The pin U/ $\overline{\text{D}}$ input determines the direction of the counting. The terminal count output pin $\overline{\text{TC}}$ output is normally HIGH and goes LOW, provided that pin $\overline{\text{CET}}$ is LOW, when a counter reaches 15 in the count up mode. The pin $\overline{\text{TC}}$ output state is not a function of the count-enable parallel (pin $\overline{\text{CEP}}$) input level. Since pin $\overline{\text{TC}}$ signal is derived by decoding the flip-flop states, there exists the possibility of decoding spikes on pin $\overline{\text{TC}}$. For this reason the use of pin $\overline{\text{TC}}$ as a clock signal is not recommended; see the following logic equations:

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count enable = \overline{CEP} \bullet \overline{CET} \bullet \overline{PE}

count up: TC = Q3 \bullet Q2 \bullet Q1 \bullet Q0 \bullet CET \bullet U/\overline{D}

count down: TC = \overline{Q3} \bullet \overline{Q2} \bullet \overline{Q1} \bullet \overline{Q0} \bullet CET \bullet \overline{U}/D
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2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Up/down counting
- Two count enable inputs for n-bit cascading
- Built-in look-ahead carry capability
- Presettable for programmable operation
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

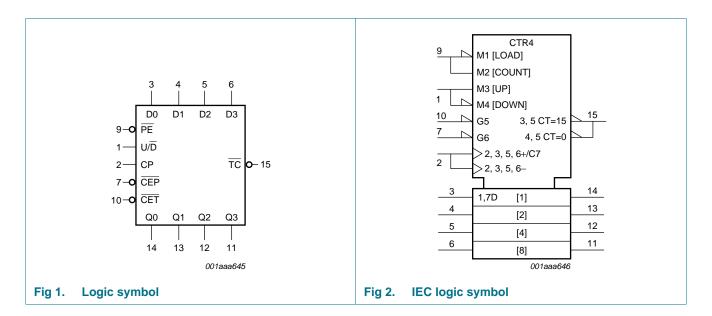
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3. Ordering information

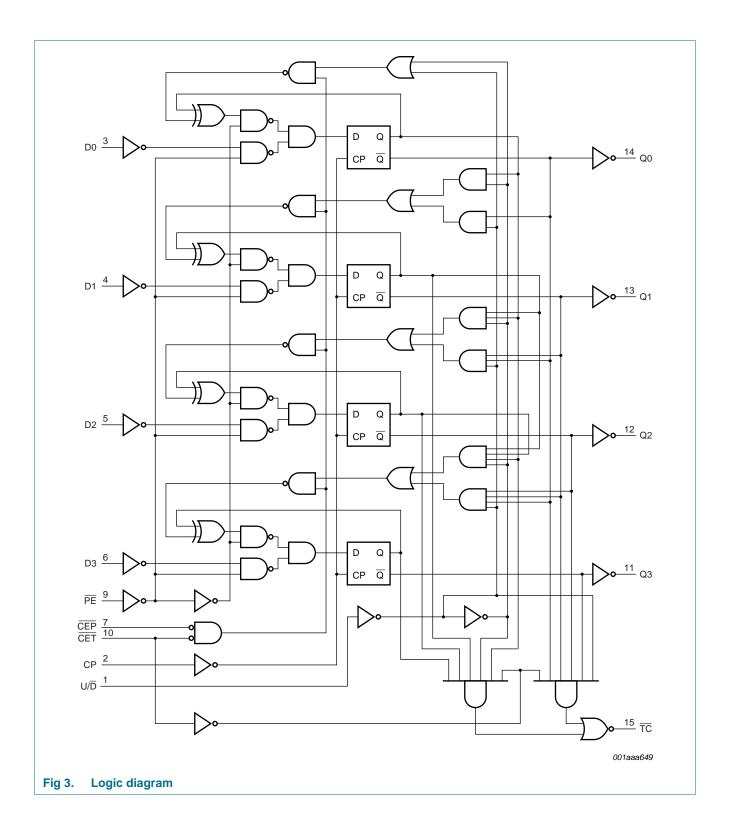
Table 1. Ordering information

Type number	Temperature range	Package		
		Name	Description	Version
74LVC169D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74LVC169DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74LVC169PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74LVC169BQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 \times 3.5 \times 0.85 mm	SOT763-1

4. Functional diagram



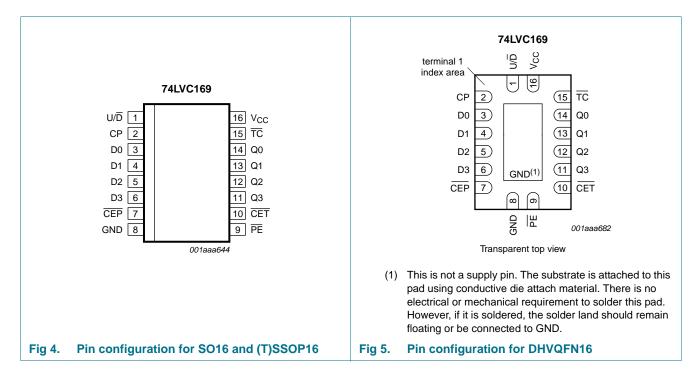
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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
U/D	1	up/down control input
СР	2	clock input (LOW-to-HIGH, edge-triggered)
D0 to D3	3, 4, 5, 6	data input
CEP	7	count enable input (active LOW)
GND	8	ground (0 V)
PE	9	parallel enable input (active LOW)
CET	10	count enable carry input (active LOW)
Q0 to Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output (active LOW)
V_{CC}	16	supply voltage

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6. Functional description

Table 3. Function table[1]

Operating mode	Input		Output	Output				
	СР	U/D	CEP	CET	PE	Dn	Qn	TC
Parallel load (Dn to Qn)	\uparrow	Χ	Χ	Χ	I	I	L	*
	\uparrow	Χ	Χ	Χ	I	h	Н	*
Count up (increment)	\uparrow	h	I	I	h	Х	count up	*
Count down (decrement)	\uparrow	I	I	I	h	Х	count down	*
Hold (do nothing)	\uparrow	Χ	h	Χ	h	Χ	qn	*
	\uparrow	Χ	Χ	Χ	h	Χ	qn	Н

[1] H = HIGH voltage level steady state

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition

L = LOW voltage level steady state

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

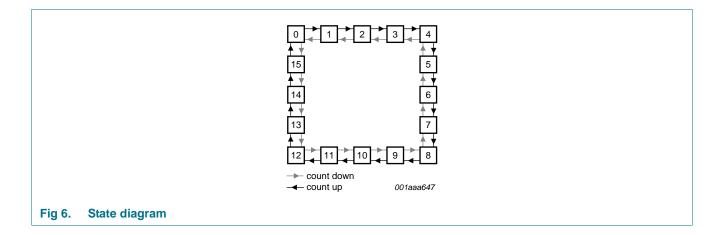
qn = Lower case letters indicate state of referenced output prior to the LOW-to-HIGH clock transition

X = don't care

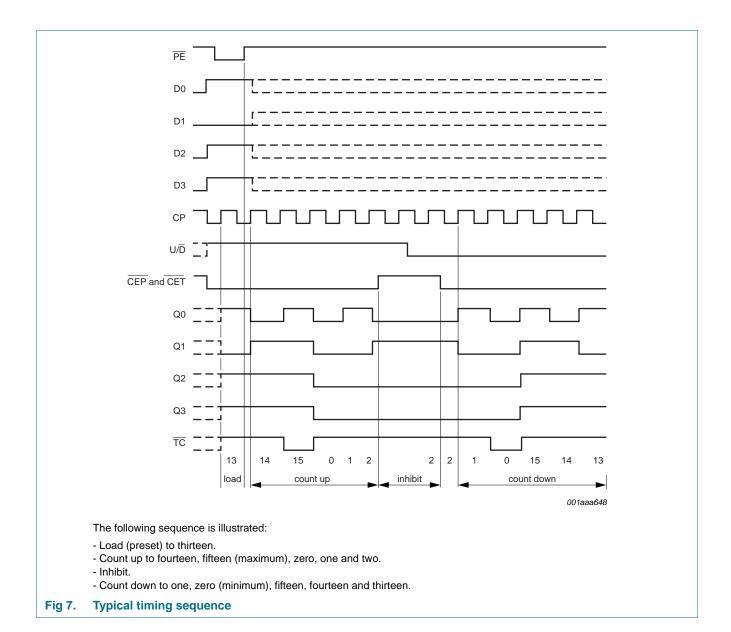
↑ = LOW-to-HIGH clock transition

* = The \overline{TC} is LOW when \overline{CET} is LOW and the counter is at terminal count

Terminal count up is (HHHH) and terminal count down is (LLLL)



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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	$V_I < 0 V$	-50	-	mA
VI	input voltage		[<u>1</u>] -0.5	+5.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage		<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
Io	output current		-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3] _	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V_{CC}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.
For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.
For DHVQFN16 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

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9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V_{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V_{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	$V_{CC}-0.2$	-	-	V _{CC} - 0.3	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
l _l	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ
Δl _{CC}	additional supply current	per input pin; V_{CC} = 2.7 V to 3.6 V; V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A	-	5	500	-	5000	μΑ
C _I	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_I = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

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10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	−40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	CP to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	17	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	7.1	13.1	1.5	15.1	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.4	4.1	7.4	2.4	8.6	ns
		V _{CC} = 2.7 V		1.5	3.9	7.2	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.7	6.6	1.5	10.0	ns
		CP to TC; see Figure 8							
		V _{CC} = 1.2 V		-	21	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.0	8.5	14.9	2.0	17.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.0	4.9	8.4	3.0	9.7	ns
		V _{CC} = 2.7 V		1.5	4.7	8.8	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	4.4	7.5	1.5	9.5	ns
		CET to TC; see Figure 9	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.6	12.3	1.5	14.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.2	3.8	7.0	2.2	8.1	ns
		V _{CC} = 2.7 V		1.5	4.0	7.2	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.4	6.2	1.5	8.0	ns
		U/D to TC; see Figure 10	[2]						
		V _{CC} = 1.2 V		-	21	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	7.3	13.7	1.0	15.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	4.2	7.7	1.7	8.9	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	4.4	8.2	1.5	10.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.8	6.9	1.5	9.0	ns
t _W	pulse width	CP HIGH or LOW; see Figure 8							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		6.0	-	-	6.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		4.0	1.2	-	4.0	-	ns

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 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t_{su}	set-up time	Dn to CP; see Figure 11							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		5.5	-	-	5.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		4.5	-	-	4.5	-	ns
		$V_{CC} = 2.7 \text{ V}$		3.0	-	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.5	1.0	-	2.5	-	ns
		PE to CP; see Figure 11							
		V _{CC} = 1.65 V to 1.95 V		4.5	-	-	4.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		3.5	-	-	3.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		3.0	1.2	-	3.0	-	ns
		U/D to CP; see Figure 12							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		9.0	-	-	9.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		7.0	-	-	7.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		6.5	-	-	6.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		5.5	2.8	-	5.5	-	ns
		CEP, CET to CP; see Figure 12							
		V _{CC} = 1.65 V to 1.95 V		9.0	-	-	9.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		6.0	-	-	6.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		5.5	-	-	5.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		4.5	2.1	-	4.5	-	ns
t _h	hold time	Dn, PE, CEP, CET, U/D to CP; see Figure 11 and 12							
		V _{CC} = 1.65 V to 1.95 V		1.0	-	-	1.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	-	-	1.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		0.0	-	-	0.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5	0.0	-	0.5	-	ns
f _{max}	maximum	see Figure 8							
	frequency	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		100	-	-	80	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		125	-	-	100	-	MHz
		$V_{CC} = 2.7 \text{ V}$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		150	200	-	120	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns

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 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
C_{PD}	power dissipation	per input pin; $V_I = GND$ to V_{CC}							
	capacitance	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	12.7	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	16.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	19.7	-	-	-	pF

- [1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \sum (C_L \times V_{CC}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

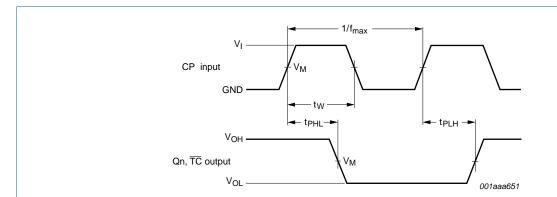
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volt

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs}$

11. Waveforms

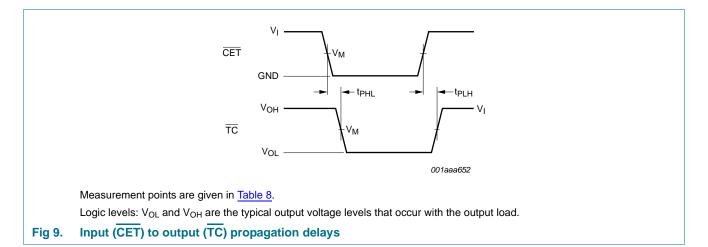


Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 8. Clock (CP) to outputs (Qn, TC) propagation delays, the clock pulse width, and the maximum frequency

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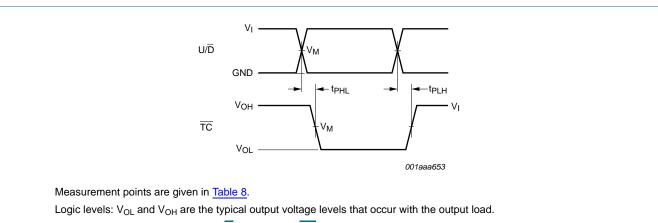
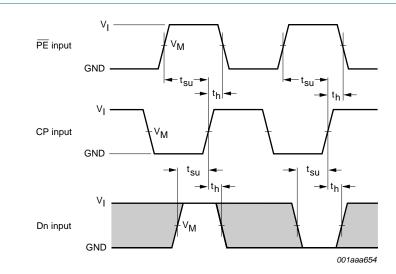


Fig 10. The up/down control input (U/\overline{D}) to output (\overline{TC}) propagation delays

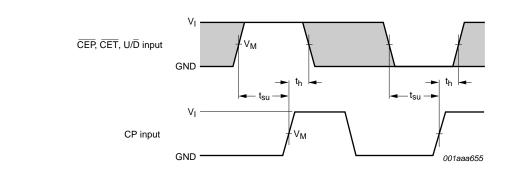
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The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 11. Set-up and hold times for the input (Dn) and parallel enable input (PE)



The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

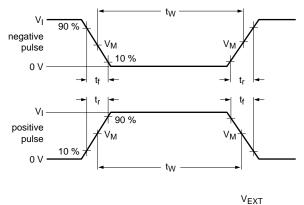
Logic levels: V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

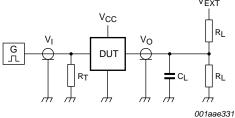
Fig 12. Set-up and hold times for count enable inputs (CEP and CET) and control input (U/D)

Table 8. Measurement points

Supply voltage	Input		Output
V _{CC}	VI	V _M	V _M
1.2 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
1.65 V to 1.95 V	V _{CC}	$0.5 \times V_{CC}$	0.5 × V _{CC}
2.3 V to 2.7 V	V _{CC}	$0.5 \times V_{CC}$	0.5 × V _{CC}
2.7 V	2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V

Presettable synchronous 4-bit up/down binary counter





Test data is given in Table 9.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 13. Test circuit for measuring switching times

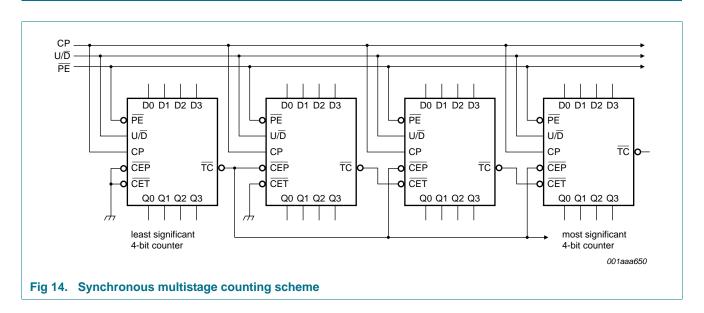
Table 9. Test data

Supply voltage	Input		Load	Load					
V _{CC}	V _I	t _r , t _f	C _L	R _L	t _{PLH} , t _{PHL}				
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ[1]	open				
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ[1]	open				
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500 Ω	open				
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open				
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open				

[1] The circuit performs better when R_L = 1000 k Ω .

Presettable synchronous 4-bit up/down binary counter

12. Application information

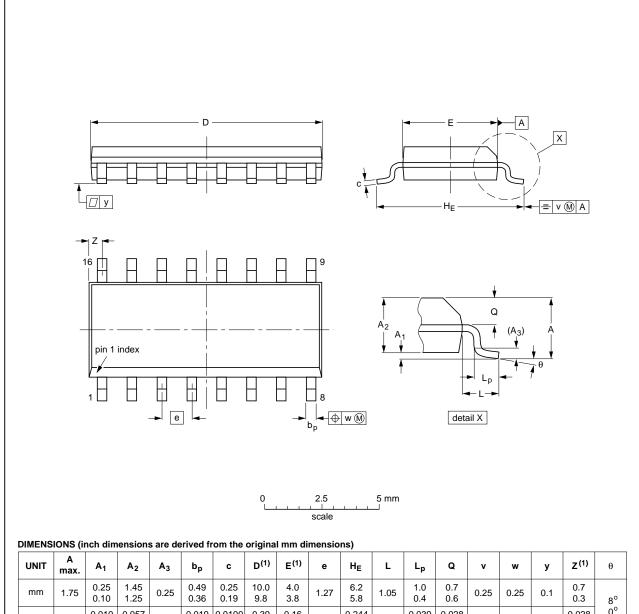


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13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	ø	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	l	0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012			99-12-27 03-02-19	

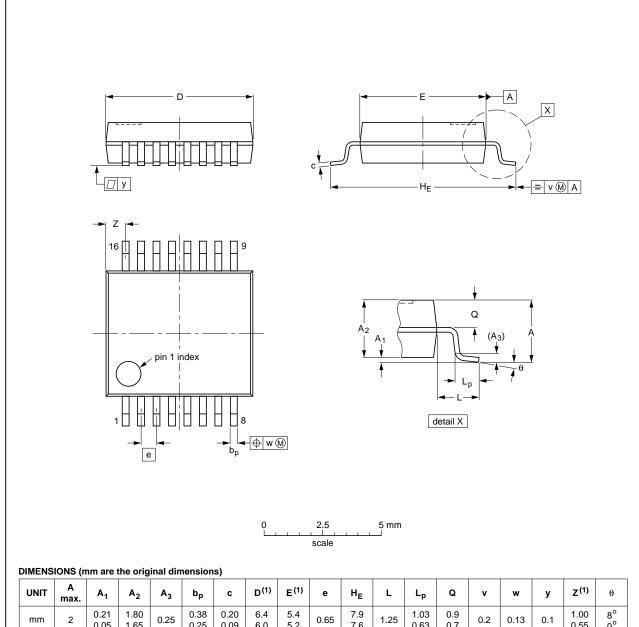
Fig 15. Package outline SOT109-1 (SO16)

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Presettable synchronous 4-bit up/down binary counter

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ	
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°	

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

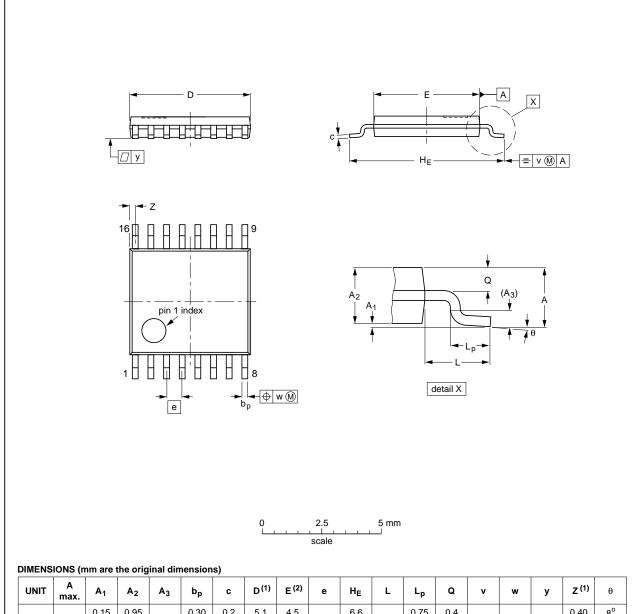
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT338-1		MO-150			99-12-27 03-02-19	

Fig 16. Package outline SOT338-1 (SSOP16)

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNIT	max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT403-1		MO-153			99-12-27 03-02-18

Fig 17. Package outline SOT403-1 (TSSOP16)

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Presettable synchronous 4-bit up/down binary counter

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

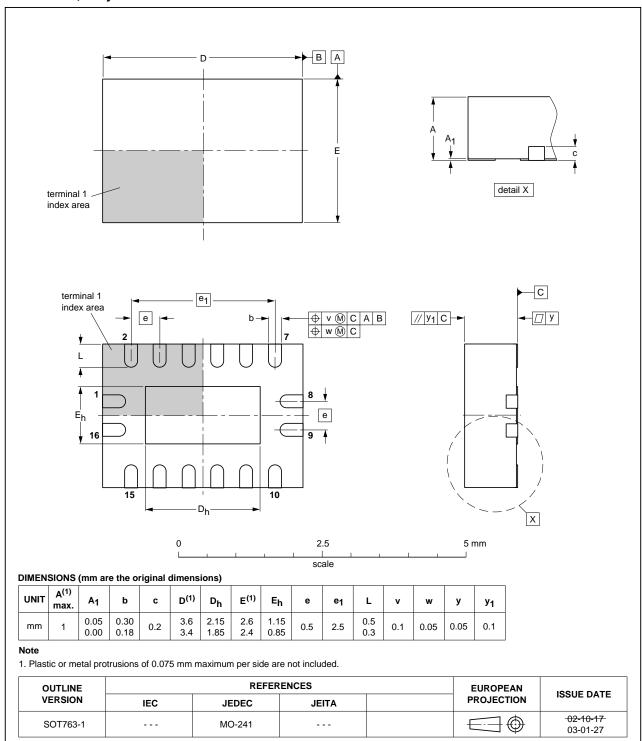


Fig 18. Package outline SOT763-1 (DHVQFN16)

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Presettable synchronous 4-bit up/down binary counter

14. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 11. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC169 v.6	20121129	Product data sheet	-	74LVC169 v.5
Modifications:	• <u>Table 4</u> , <u>Table ranges</u> .	ole 5, Table 6, Table 7, Table	e 8 and Table 9: values	added for lower voltage
74LVC169 v.5	20090608	Product data sheet	-	74LVC169 v.4
74LVC169 v.4	20041014	Product specification	-	74LVC169 v.3
74LVC169 v.3	20040512	Product specification	-	74LVC169 v.2
74LVC169 v.2	19980520	Product specification	-	74LVC169 v.1
74LVC169 v.1	19960823	Product specification	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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